

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
A Leam Choi	04/30/2008
Young Jin Woo	04/30/2008
Junwoo Myung	04/30/2008
RECEIVING PARTY DATA	
Name:	STATS ChipPAC Ltd.
Street Address:	5 Yishun Street 23
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	768442
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12122631
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	27-501
NAME OF SUBMITTER:	Mikio Ishimaru
<p>Total Attachments: 3</p> <p>source=27-501_Assignment#page1.tif</p>	

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ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

PACKAGE SYSTEM INCORPORATING A FLIP-CHIP ASSEMBLY

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 5 Yishun Street 23, Singapore 768442 (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;


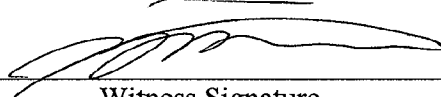

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.


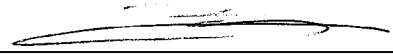

5. Said Assignor(s) hereby authorize and request the attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 12/122,631 Filing Date: May 16, 2008.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

 _____ A Leam Choi	<u>Apr. 30. 2008.</u> _____ Date
 _____ Witness Signature	 _____ Witness Signature
<u>Jung In Yang</u> _____ Print Witness Name	<u>Deok Kyung Yang</u> _____ Print Witness Name
<u>Apr. 30. 2008.</u> _____ Date	<u>Apr. 30. 2008</u> _____ Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

 _____ Young Jin Woo	<u>Apr. 30. 2008</u> _____ Date
 _____ Witness Signature	 _____ Witness Signature
<u>Young Min Kim</u> _____ Print Witness Name	<u>Hyun IL Bae</u> _____ Print Witness Name
<u>Apr. 30. 2008</u> _____ Date	<u>Apr. 30. 2008</u> _____ Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.




Junwoo Myung

Apr. 30. 2008

Date



Witness Signature



Witness Signature

Byung-mo K. Jang

Print Witness Name

Choong hwan Kwon

Print Witness Name

Apr. 30. 2008

Date

Apr. 30. 2008

Date